INTEGRATED CIRCUITS

DATA SHEET

74LV2518-input multiplexer (3-State)

Product specification Supersedes data of 1997 Apr 10 IC24 Data Handbook 1998 May 20







Philips Semiconductors Product specification

8-input multiplexer (3-State)

74LV251

FEATURES

- Optimized for low voltage applications: 1.0 to 3.6 V
- ullet Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- \bullet Typical V_{OLP} (output ground bounce) < 0.8 V at V_{CC} = 3.3 V, T_{amb} = 25°C
- \bullet Typical V_{OHV} (output V_{OH} undershoot) > 2 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}\text{C}$
- True and complement outputs
- Both outputs are 3-State for further multiplexer expansion
- Multifunction capability
- Permits multiplexing from n-lines to one line
- Output capability: standard
- I_{CC} category: MSI

DESCRIPTION

The 74LV251 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT251.

The 74LV251 is an 8-input multiplexer with 8 binary inputs (I_0 to I_7), an output enable input (\overline{OE}) and three select inputs (S_0 , S_1 , S_2). One of the eight binary inputs is selected by the select inputs and is routed to the outputs (\overline{Y} , Y). Both outputs are in the high impedance OFF-state (Z) when the output enable input is HIGH, allowing multiplexer expansion by tying the outputs.

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5 \text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay I_n to Y I_n to \overline{Y} S_n to Y S_n to \overline{Y}	C _L = 15 pF; V _{CC} = 3.3 V	14 16 19 20	ns
C _I	Input capacitance		3.5	pF
C _{PD}	Power dissipation capacitance per gate	$V_{CC} = 3.3 \text{ V}$ $V_I = \text{GND to } V_{CC}^1$	44	pF

NOTE:

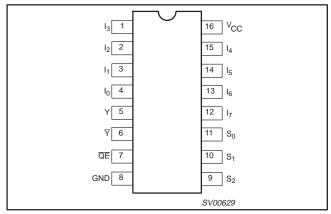
1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W) $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; C_L = output load capacitance in pF; f_o = output frequency in MHz; V_{CC} = supply voltage in V; $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
16-Pin Plastic DIL	-40°C to +125°C	74LV251 N	74LV251 N	SOT38-4
16-Pin Plastic SO	-40°C to +125°C	74LV251 D	74LV251 D	SOT109-1
16-Pin Plastic SSOP Type II	-40°C to +125°C	74LV251 DB	74LV251 DB	SOT338-1
16-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV251 PW	74LV251PW DH	SOT403-1

74LV251

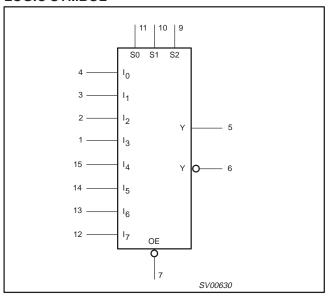
PIN CONFIGURATION



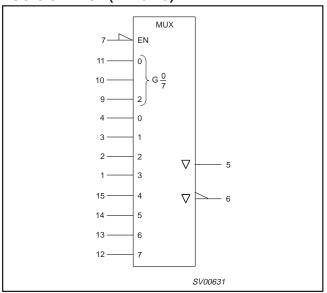
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
4, 3, 2, 1, 15, 14, 13, 12	I ₀ to I ₇	Multiplexer inputs
5	Υ	Multiplexer output
6	Y	Complementary multiplexer output
7	ŌĒ	3-State output enable input (active LOW)
8	GND	Ground (0 V)
11, 10, 9	S ₀ to S ₂	Select inputs
16	V _{CC}	Positive supply voltage

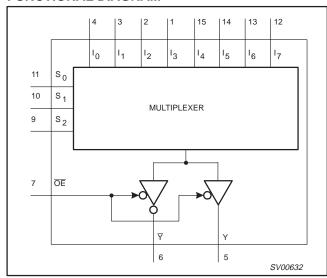
LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



FUNCTIONAL DIAGRAM



Philips Semiconductors Product specification

8-input multiplexer (3-State)

74LV251

FUNCTION TABLE

					INP	UTS						OUT	PUTS
OE	S ₂	S ₁	S ₀	l ₀	I ₁	l ₂	l ₃	I ₄	l ₅	I ₆	I ₇	Y	Υ
Н	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Z	Z
L	L	L	L	L	Х	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	L	Н	Х	Х	Х	Х	Х	X	Х	L	Н
L	L	L	Н	X	L	Χ	Х	Χ	Х	Х	Х	Н	L
L	L	L	Н	Х	Н	Х	Х	Х	Х	Х	Х	L	Н
L	L	Н	L	Х	Х	L	Х	Х	Х	Х	Х	Н	L
L	L	Н	L	X	X	Н	Х	Х	Х	Х	Х	L	Н
L	L	Н	Н	Х	Х	Х	L	Х	Х	Х	Х	Н	L
L	L	Н	Н	Х	Х	Х	Н	Х	Х	Х	Х	L	Н
L	Н	L	L	Х	Х	Х	Х	L	Х	Х	Х	Н	L
L	Н	L	L	Х	Х	Х	Х	Н	Х	Х	Х	L	Н
L	Н	L	Н	Х	Х	Х	Х	Х	L	Х	Х	Н	L
L	Н	L	Н	X	Х	Х	Х	Х	Н	Х	Х	L	Н
L	Н	Н	L	Х	Х	Х	Х	Х	Х	L	Х	Н	L
L	Н	Н	L	Х	Х	Х	Х	Х	Х	Н	Х	L	н
L	Н	Н	Н	Х	Х	Х	Х	Х	Х	Х	L	Н	L
L	Н	Н	Н	Х	Х	Х	Х	Х	Х	Х	Н	L	Н

NOTES:

H = HIGH voltage level L = LOW voltage level

don't care

high impedance OFF-state

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V _{CC}	DC supply voltage	See Note 1	1.0	3.3	3.6	V
VI	Input voltage		0	-	V _{CC}	V
Vo	Output voltage		0	_	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 1.0V \text{ to } 2.0V$ $V_{CC} = 2.0V \text{ to } 2.7V$ $V_{CC} = 2.7V \text{ to } 3.6V$	- - -	- - -	500 200 100	ns/V

NOTE:

1998 May 20

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^{1.} The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.

Philips Semiconductors Product specification

8-input multiplexer (3-State)

74LV251

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
± I _{IK}	DC input diode current	$V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5V$	20	mA
± I _{OK}	DC output diode current	$V_{O} < -0.5 \text{ or } V_{O} > V_{CC} + 0.5V$	50	mA
±10	DC output source or sink current – standard outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25	mA
± I _{GND} , ± I _{CC}	DC V _{CC} or GND current for types with – standard outputs		50	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40	0°C to +8∜	5°C	-40°C to	+125°C	UNIT
			MIN	TYP ¹	MAX	MIN	MAX]
		V _{CC} = 1.2 V	0.9			0.9		
V _{IH}	HIGH level Input voltage	V _{CC} = 2.0 V	1.4			1.4		V
	1	V _{CC} = 2.7 to 3.6 V	2.0			2.0]
		V _{CC} = 1.2 V			0.3		0.3	
V_{IL}	LOW level Input voltage	V _{CC} = 2.0 V			0.6		0.6	٧
	Vollago	V _{CC} = 2.7 to 3.6 V			0.8		0.8	1
		$V_{CC} = 1.2 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu A$		1.2				
	HIGH level output	$V_{CC} = 2.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$	1.8	2.0		1.8		
V _{OH}	voltage; all outputs	$V_{CC} = 2.7 \text{ V; } V_I = V_{IH} \text{ or } V_{IL;} -I_O = 100 \mu A$	2.5	2.7		2.5		V
		$V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; -I_O = 100 \mu\text{A}$	2.8	3.0		2.8		1
V _{OH}	HIGH level output voltage; STANDARD outputs	$V_{CC} = 3.0 \text{ V}; V_{I} = V_{IH} \text{ or } V_{IL}; -I_{O} = 6\text{mA}$	2.40	2.82		2.20		V
		$V_{CC} = 1.2 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$		0				
.,	LOW level output	$V_{CC} = 2.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$		0	0.2		0.2	
V _{OL}	voltage; all outputs	$V_{CC} = 2.7 \text{ V; } V_I = V_{IH} \text{ or } V_{IL;} I_O = 100 \mu A$		0	0.2		0.2	1 '
		$V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu\text{A}$		0	0.2		0.2	1
V _{OL}	LOW level output voltage; STANDARD outputs	$V_{CC} = 3.0 \text{ V}; V_I = V_{IH} \text{ or } V_{IL}; I_O = 6\text{mA}$		0.25	0.40		0.50	V

5

1998 May 20

^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

Philips Semiconductors Product specification

8-input multiplexer (3-State)

74LV251

DC ELECTRICAL CHARACTERISTICS (Continued)

			LIMITS							
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +8	5°C	-40°C to	UNIT			
			MIN	TYP ¹	MAX	MIN	MAX			
I _I	Input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND}$			1.0		1.0	μА		
Icc	Quiescent supply current; MSI	$V_{CC} = 3.6 \text{ V}; V_{I} = V_{CC} \text{ or GND}; I_{O} = 0$			20.0		160	μА		
Δl _{CC}	Additional quiescent supply current per input	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}; V_1 = V_{CC} - 0.6 \text{ V}$			500		850	μА		

NOTE:

AC CHARACTERISTICS

GND = 0V; t_r = t_f = 2.5ns; C_L = 50pF; R_L = 1K Ω

			CONDITION			LIMITS				
SYMBOL	PARAMETER	WAVEFORM	CONDITION	_	40 to +85 °	C	-40 to	+125 °C	UNIT	
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX		
			1.2		90					
	Propagation delay	Figure 4	2.0		31	58		70		
t _{PHL} /t _{PLH}	I _n to Y	Figure 1	2.7		23	43		51	ns	
			3.0 to 3.6		17 ²	34		41		
			1.2		100					
	Propagation delay	F: 0	2.0		34	65		77		
t _{PHL} /t _{PLH}	I_n to \overline{Y}	Figure 2	2.7		25	48		56	ns	
			3.0 to 3.6		19 ²	38		45		
			1.2		120					
t _{PHL} /t _{PLH}	Propagation delay S_n to Y	Figure 1	2.0		41	77		92	ns	
			2.7		30	56		68		
			3.0 to 3.6		23 ²	45		54		
			1.2		125					
	Propagation delay	F: 0	2.0		43	82		97		
t _{PHL} /t _{PLH}	Propagation delay S_n to \overline{Y}	Figure 2	2.7		31	60		71	ns	
			3.0 to 3.6		24 ²	48		57		
			1.2		65					
	3-State output disable time	F'0	2.0		22	43		51		
t _{PZH} /t _{PZL}	$\frac{3-\text{State output disable time}}{\text{OE}}$ to Y, \overline{Y}		31		38	ns				
			3.0 to 3.6		12 ²	25		30		
			1.2		60					
	3-State output disable time	Figure 0	2.0		22	39		48	1	
t _{PHZ} /t _{PLZ}	\overline{OE} to Y, \overline{Y}	Figure 2	2.7		17	29		36	ns	
			3.0 to 3.6		13 ²	24		29		

6

1998 May 20

^{1.} All typical values are measured at T_{amb} = 25°C.

^{1.} Unless otherwise stated, all typical values are measured at T_{amb} = 25°C 2. Typical values are measured at V_{CC} = 3.3 V.

Philips Semiconductors Product specification

8-input multiplexer (3-State)

74LV251

AC WAVEFORMS

 V_M = 1.5 V at $V_{CC} \geq$ 2.7 V

 V_{M} = 0.5 V × V_{CC} at V_{CC} < 2.7 V

 $V_{\mbox{\scriptsize OL}}$ and $V_{\mbox{\scriptsize OH}}$ are the typical output voltage drop that occur with the output load.

 $V_X = V_{OL} + 0.3 \text{ V at } V_{CC} \ge 2.7 \text{ V}$

 $V_X = V_{OL} + 0.1 \times V_{CC}$ at $V_{CC} < 2.7 \text{ V}$

 $\begin{aligned} & V_Y = V_{OH} - 0.3 \text{ V at } V_{CC} \geq 2.7 \text{V} \\ & V_Y = V_{OH} - 0.1 \times V_{CC} \text{ at } V_{CC} < 2.7 \text{ V} \end{aligned}$

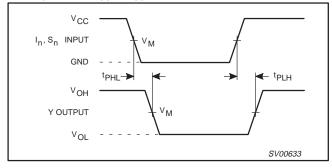


Figure 1. Multiplexer input (In) and select input (Sn) to output (Y) propagation delays.

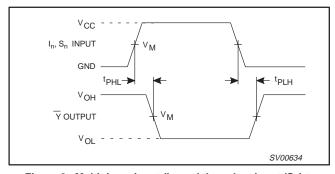


Figure 2. Multiplexer input (I_n) and the select input (S_n) to output (\overline{Y}) propagation delays.

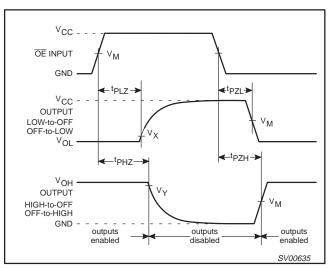


Figure 3. 3-State enable and disable times

TEST CIRCUIT

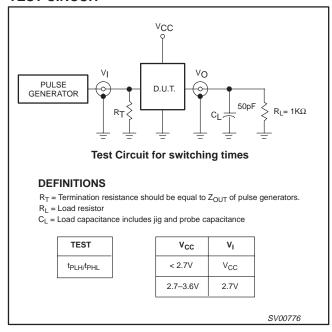


Figure 4. Load circuitry for switching times.

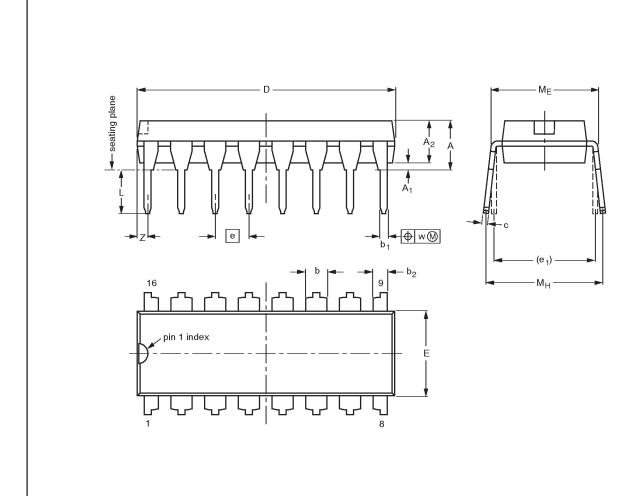
1998 May 20

7

74LV251

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

scale

10 mm

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

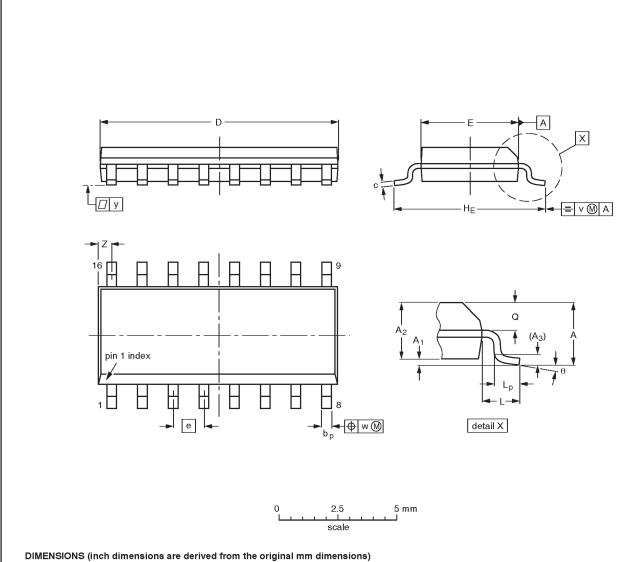
OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT38-4				□ •	92-11-17 95-01-14

8

74LV251

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	Α1	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.0098 0.0039		0.01		0.0098 0.0075	0.39 0.38	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

Note

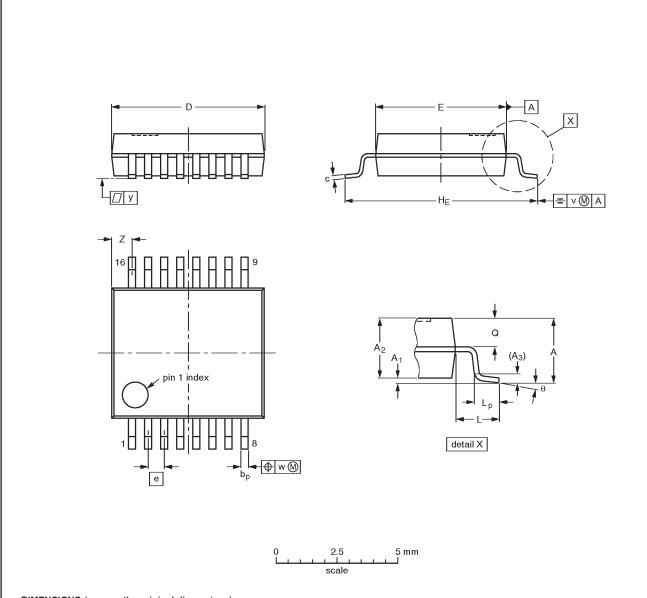
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT109-1	076E07S	MS-012AC			91-08-13 95-01-23	

74LV251

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	рb	c	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

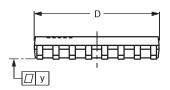
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

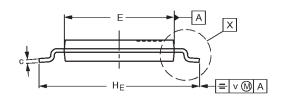
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VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT338-1		MO-150AC				94-01-14 95-02-04	

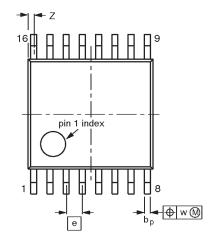
74LV251

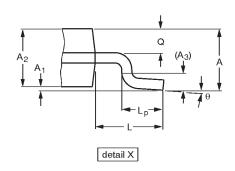
TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1











DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	А3	bp	O	D ⁽¹⁾	E ⁽²⁾	е	HE	٦	Lp	ø	v	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC		PROJECTION	ISSUE DATE	
SOT403-1		MO-153				-94-07-12 95-04-04

74LV251

DEFINITIONS							
Data Sheet Identification	Product Status	Definition					
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.					
Preliminary Specification Preproduction Product		This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.					
Product Specification	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.					

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